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Rabbit anti-Mouse IgG1, kappa Antibody



Publication



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Overview			
Quantity:	1 mg		
Target:	IgG1, kappa		
Reactivity:	Mouse		
Host:	Rabbit		
Clonality:	Polyclonal		
Application:	ELISA, Immunohistochemistry (Frozen Sections) (IHC (fro)), Immunohistochemistry (Paraffinembedded Sections) (IHC (p)), Western Blotting (WB)		
Product Details			
Isotype:	IgG		
Purification:	Purified by Protein A.		
Target Details			
Target:	IgG1, kappa		
Target: Alternative Name:	IgG1, kappa IgG1, Kappa Light Chain (IgG1, kappa Products)		

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time point is estimated to be 1011 variants.

and to recruit other cells and molecules to destroy the antigen. The variability of the IgG pool is

generated by somatic recombination and the number of specificities in an individual at a given

Application Details

Application Notes:	WB 1:500-2000 ELISA 1:500-2000 IHC-P 1:500-2000 IHC-F 1:500-2000
Restrictions:	For Research Use only
Handling	
Format:	Lyophilized
Storage:	-20 °C
Storage Comment:	Store at -20°C
Expiry Date:	12 months
Publications	
Product cited in:	Stumpf, Wimmer, Lorenz, Stieger: "Creation of different bioluminescence resonance energy transfer based biosensors with high affinity to VEGF." in: PLoS ONE , Vol. 15, Issue 3, pp. e0230344, (2020) (PubMed).
	Chen, Hsueh, Lee, Tsai, Tsai, Chiang: "FGF primes angioblast formation by inducing ETV2 and LM02 via FGFR1/BRAF/MEK/ERK." in: Cellular and molecular life sciences : CMLS , (2020) (PubMed).

Keys, Wetter, Hang, Rutschmann, Russo, Mally, Steffen, Zuppiger, Müller, Schneider, Faridmoayer, Lin, Aebi: "A biosynthetic route for polysialylating proteins in Escherichia coli." in: **Metabolic engineering**, Vol. 44, pp. 293-301, (2018) (PubMed).